

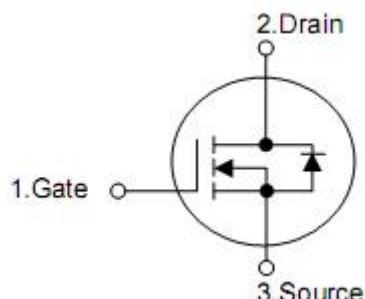
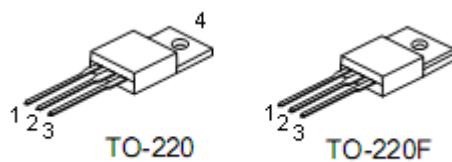
1. Description

The KNX6650A-N-Channel enhancement mode silicon gate power MOSFET is designed for high voltage, high speed power switching applications such as high efficiency switched mode power supplies, active power factor correction, electronic lamp ballasts based on half bridge topology

2. Features

- Proprietary New Planar Technology
- $R_{DS(ON),typ.}=0.33\ \Omega @ V_{GS}=10V$
- Low Gate Charge Minimize Switching Loss
- Fast Recovery Body Diode

3. Pin configuration



Pin	Function
1	Gate
2	Drain
3	Source
4	Drain

4. Ordering Information

Part Number	Package	Brand
KNF6650A	TO-220F	KIA
KNP6650A	TO-220	KIA

5. Absolute maximum ratings

TC=25 °C unless otherwise specified

Parameter	Symbol	Ratings		Unit
		TO220	TO22F	
Drain-to-Source Voltage ^[1]	V _{DSS}	500		V
Gate-to-Source Voltage	V _{GSS}	±30		
Continuous Drain Current	I _D	15		A
Continuous Drain Current @ T _C =100 °C		Figure3		
Pulsed Drain Current at V _{GS} =10V ^[2]	I _{DM}	Figure6		
Single Pulse Avalanche Energy	E _{AS}	1000		mJ
Peak Diode Recovery dv/dt ^[3]	dv/dt	5.0		V/ns
Power Dissipation	P _D	140	60	W
Derating Factor above 25 °C		1.12	0.48	W/ °C
Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	T _L T _{PAK}	300 260		°C
Operating and Storage Temperature Range	T _J & T _{STG}	-55 to 150		

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

6. Thermal characteristics

Parameter	Symbol	Ratings		Units
		TO220	TO220F	
Thermal resistance, junction-ambient	R _{θJA}	62	100	°C/W
Thermal resistance, Junction-case	R _{θJC}	0.9	2.1	

7. Electrical characteristics

($T_J=25^\circ\text{C}$, unless otherwise notes)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Off characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_D=250\mu\text{A}$	500	-	-	V
Drain-to-source Leakage Current	I_{DSS}	$V_{\text{DS}}=500\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
		$V_{\text{DS}}=400\text{V}, V_{\text{GS}}=0\text{V}$ $T_C=125^\circ\text{C}$,	-	-	100	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	+100	nA
		$V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	-100	nA
On characteristics						
Static drain-source on-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_D=7.5\text{A}$	-	0.33	0.45	Ω
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_D=250\mu\text{A}$	2.0	-	4.0	V
Forward Transconductance	g_{fs}	$V_{\text{DS}}=30\text{V}, I_D=15\text{A}$	-	15	-	S
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V},$ $f=1\text{MHz}$	-	2148	-	pF
Output capacitance	C_{oss}		-	208	-	pF
Reverse transfer capacitance	C_{rss}		-	22	-	pF
Total gate charge						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=250\text{V}, I_D=15\text{A},$ $V_{\text{GS}}=10\text{V}, R_G=6.1\Omega$	-	13	-	ns
Rise time	t_r		-	28	-	ns
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	44	-	ns
Fall time	t_f		-	35	-	ns
Total gate charge	Q_g	$V_{\text{DD}}=250\text{V}, I_D=15\text{A},$ $V_{\text{GS}}=0 \text{ to } 10\text{V}$	-	46	-	nC
Gate-source charge	Q_{gs}		-	12	-	nC
Gate-drain charge	Q_{gd}		-	17	-	nC
Drain-source diode characteristics						
Drain-source diode forward voltage	V_{SD}	$V_{\text{GS}}=0\text{V}, I_s=15.0\text{A}$	-	-	1.5	V
Continuous drain-source current [4]	I_{SD}	Integral pn-diode In MOSFET	-	-	15	A
Pulsed drain-source current [4]	I_{SM}		-	-	60	A
Reverse recovery time	t_{rr}	$V_{\text{GS}}=0\text{V}, I_F=15.0\text{A}$ $dI_F/dt=100\text{A}/\mu\text{s}$	-	520	-	ns
Reverse recovery charge	Q_{rr}		-	4.5	-	μC

Note:

[1] $T_J = +25^\circ\text{C}$ to $+150^\circ\text{C}$

[2] Repetitive rating; pulse width limited by maximum junction temperature.

[3] $I_{\text{SD}} = 15\text{A}$ $di/dt < 100 \text{ A}/\mu\text{s}$, $V_{\text{DD}} < \text{BV}_{\text{DSS}}$, $T_J = +150^\circ\text{C}$.

[4] Pulse width $\leq 380\mu\text{s}$; duty cycle $\leq 2\%$.

8. Typical Characteristics

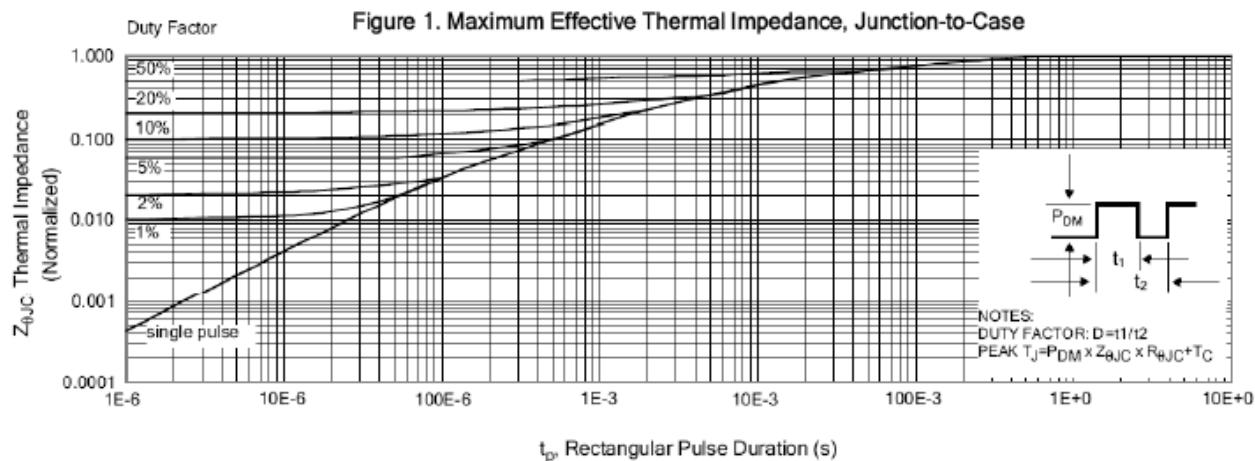


Figure 2. Maximum Power Dissipation vs Case Temperature

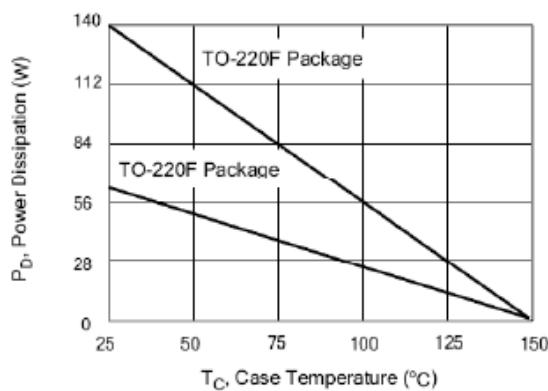


Figure 3. Maximum Continuous Drain Current vs Case Temperature

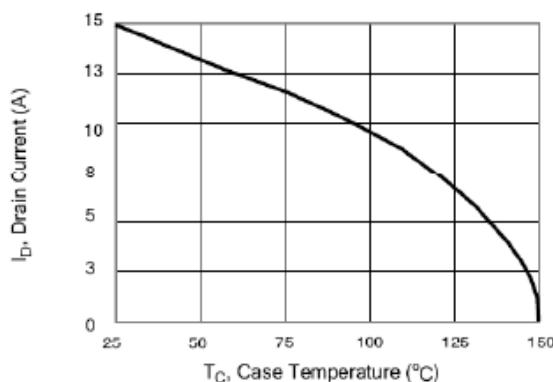


Figure 4. Typical Output Characteristics

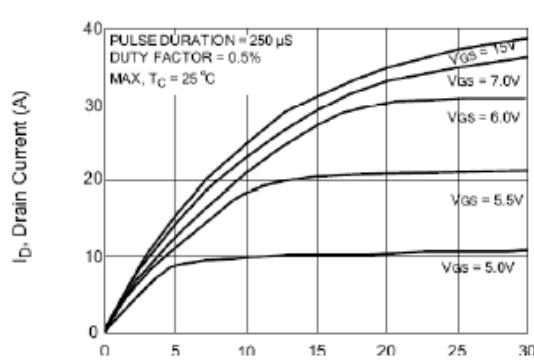


Figure 5. Typical Drain-to-Source ON Resistance vs Gate Voltage and Drain Current

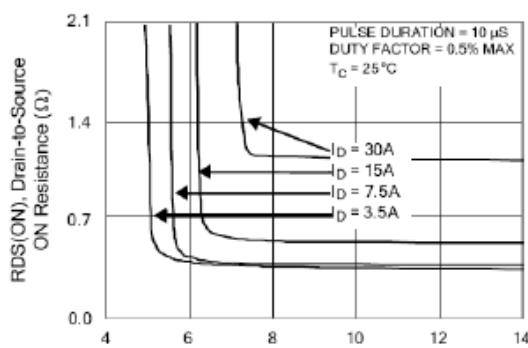


Figure 6. Maximum Peak Current Capability

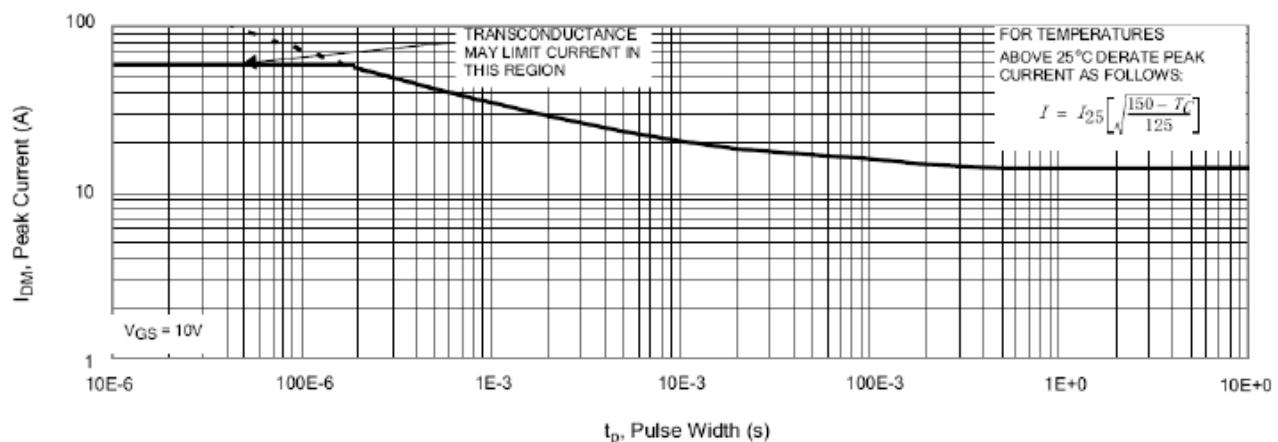


Figure 7. Typical Transfer Characteristics

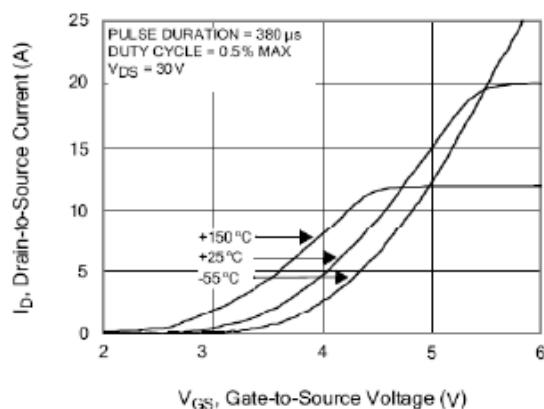


Figure 9. Typical Drain-to-Source ON Resistance vs Drain Current

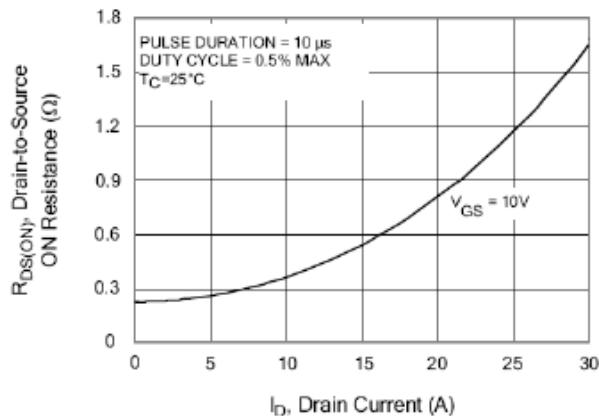


Figure 8. Unclamped Inductive Switching Capability

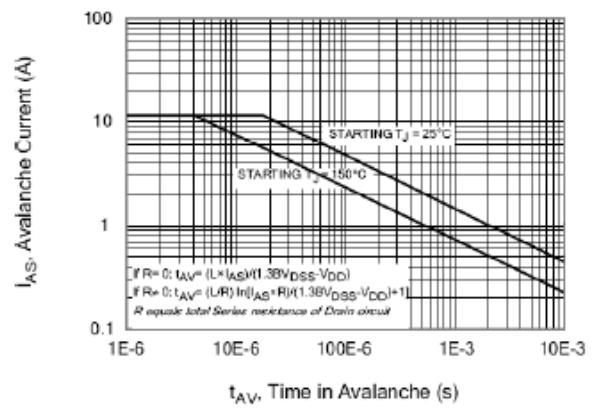


Figure 10. Typical Drain-to-Source ON Resistance vs Junction Temperature

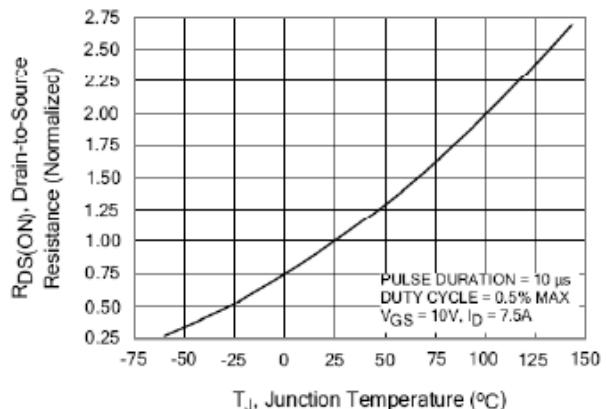


Figure 11. Typical Breakdown Voltage vs Junction Temperature

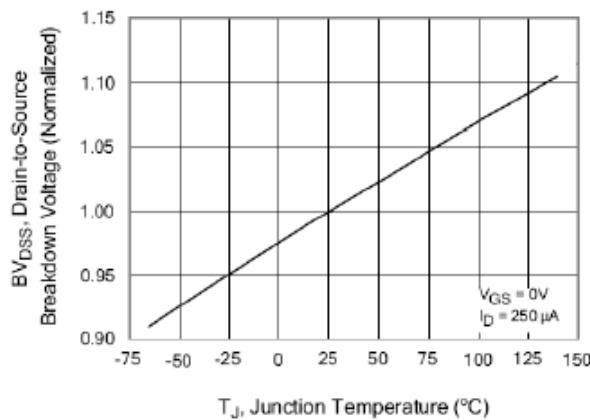


Figure 12. Typical Threshold Voltage vs Junction Temperature

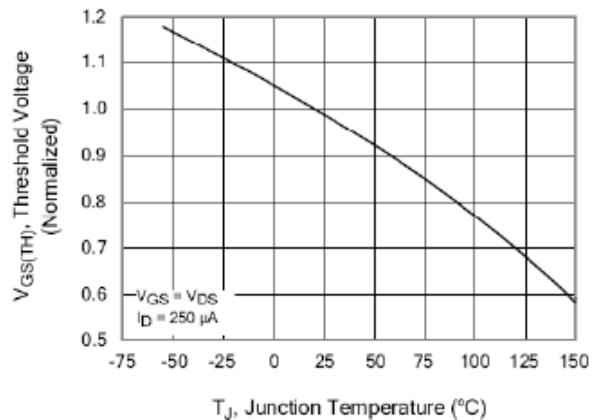


Figure 13. Maximum Forward Bias Safe Operating Area

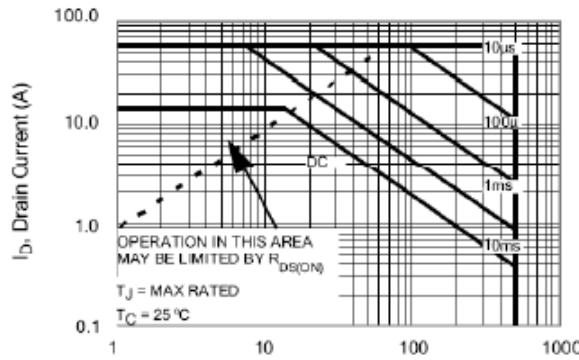


Figure 14. Typical Capacitance vs Drain-to-Source Voltage

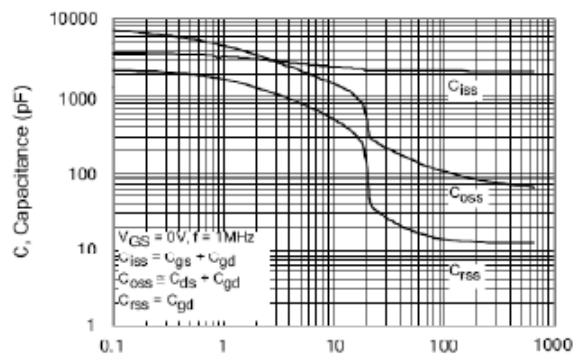


Figure 15. Typical Gate Charge vs Gate-to-Source Voltage

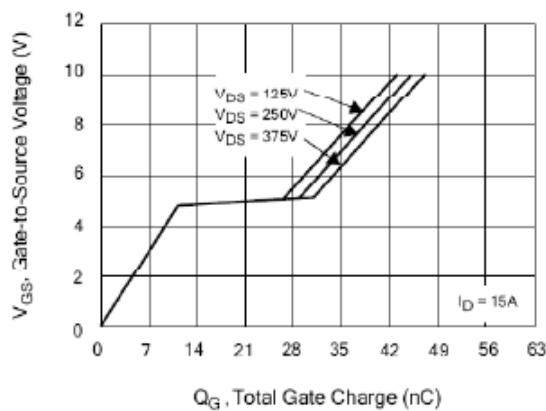
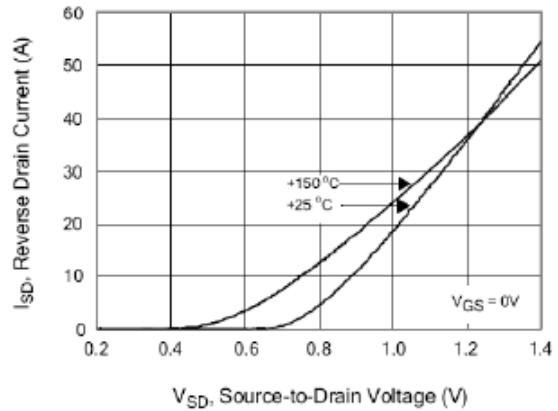


Figure 16. Typical Body Diode Transfer Characteristics



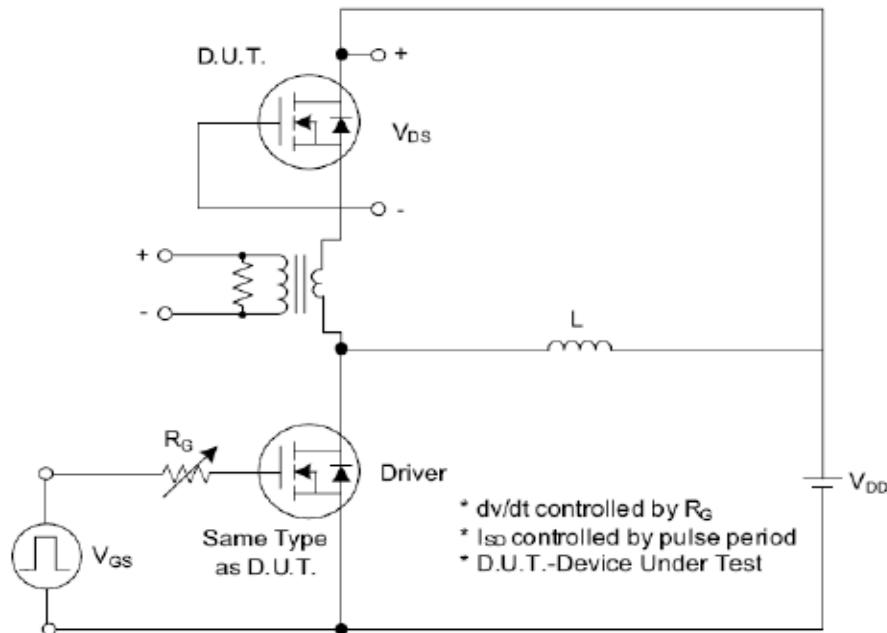


Fig. 1.1 Peak Diode Recovery dv/dt Test Circuit

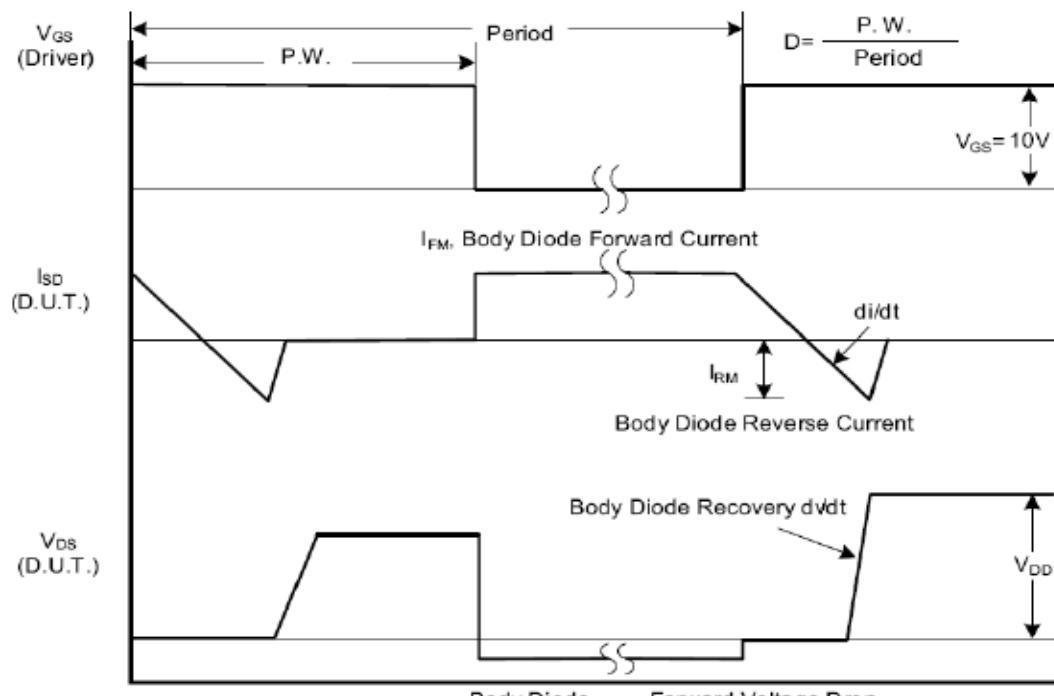


Fig. 1.2 Peak Diode Recovery dv/dt Waveforms

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